



DGD2104A

HALF-BRIDGE GATE DRIVER IN SO-8

Description

The DGD2104A is a high-voltage, high-speed gate driver capable of driving N-Channel MOSFETs and IGBTs in a half bridge configuration. High-voltage processing techniques enable the DGD2104A's highside to switch to 600V in a bootstrap operation.

The DGD2104A logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction. The DGD2104A has a fixed internal deadtime of 520ns (typical).

The DGD2104A is offered in the SO-8 (Type TH) package and operates over an extended -40°C to +125°C temperature range.

Applications

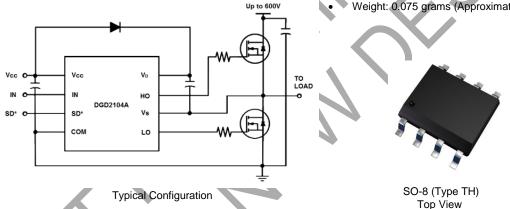
- **DC-DC Converters**
- **DC-AC Inverters**
- AC-DC Power Supplies
- Motor Controls
- **Class D Power Amplifiers**

Features

- Floating High-Side Driver in Bootstrap Operation to 600V
- Drives Two N-Channel MOSFETs or IGBTs in a Half Bridge Configuration
- 210mA Source / 360mA Sink Output Current Capability
- **Outputs Tolerant to Negative Transients**
- Internal Dead Time of 520ns to Protect MOSFETs
- Wide Low Side Gate Driver Supply Voltage: 10V to 20V
- Logic Input (IN and SD*) 3.3V Capability •
- Schmitt Triggered Logic Inputs
- Undervoltage Lockout for V_{CC} (Logic and Low Side Supply)
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony free. "Green" Device (Note 3)

Mechanical Data

- Case: SO-8 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.075 grams (Approximate)



Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DGD2104AS8-13	DGD2104A	13	12	2,500

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free

- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

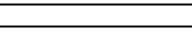
Notes:



= Manufacturer's Marking ווכ DGD2104A = Product Type Marking Code YΥ = Year (ex: 16 = 2016) WW = Week (01 to 53)



Pin Diagrams



8

7

6

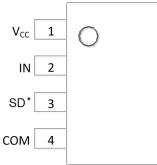
5

 V_{B}

HO

 V_{S}

LO

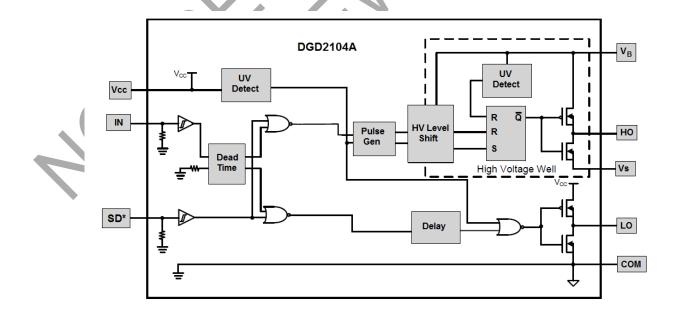


Top View: SO-8 (Type TH)

Pin Descriptions

Pin Number	Pin Name	Function
1	V _{CC}	Logic and Low Side Supply
2	IN	Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO
3	SD*	Logic Input for Shutdown, Enabled Low
4	COM	Low-Side and Logic Return
5	LO	Low-Side Gate Drive Output
6	Vs	High-Side Floating Supply Return
7	НО	High-Side Gate Drive Output
8	VB	High-Side Floating Supply

Functional Block Diagram





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Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
High-Side Floating Supply Voltage	VB	-0.3 to +624	V	
High-Side Floating Supply Offset Voltage	Vs	V _B -24 to V _B +0.3	V	
High-Side Floating Output Voltage	V _{HO}	V _S -0.3 to V _B +0.3	V	
Offset Supply Voltage Transient	dV _S / dt	50	V/ns	
Low-Side Fixed Supply Voltage	V _{CC}	-0.3 to +24	V	
Low-Side Output Voltage	V _{LO}	-0.3 to V _{CC} +0.3	V	
Logic Input Voltage (IN and SD*)	V _{IN}	-0.3 to V _{CC} +0.3	V	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	200	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL 🔷	+300	°C
Storage Temperature Range	T _{STG}	-55 to +150	
Nate: 5 When mounted an a standard JEDEC 2 Jours ED 4 haard			

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter		Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	4	VB	V _S + 10	V _S + 20	V
High Side Floating Supply Offset Voltage		Vs	(Note 6)	600	V
High Side Floating Output Voltage		Vно	Vs	VB	V
Low Side Fixed Supply Voltage		V _{CC}	10	20	V
Low Side Output Voltage		V _{LO}	0	V _{CC}	V
Logic Input Voltage (IN and SD*)		ViN	0	5	V
Ambient Temperature		TA	-40	+125	°C

Note: 6. Logic operation for V_S of -5V to +600V. Logic state held for V_S of -5V to - V_{BS} .





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DC Electrical Characteristics (V_{BIAS} (V_{CC} , V_{BS}) = 15V, @T_A = +25°C, unless otherwise specified.) (Note 7)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Logic "1" (IN) & Logic "0" (SD*) Input Voltage	VIH	2.5	_	-	V	V_{CC} = 10V to 20V
Logic "0" (IN) & Logic "1" (SD*) Input Voltage	VIL	-	-	0.8	V	V_{CC} = 10V to 20V
High Level Output Voltage, V _{BIAS} - V _O	V _{OH}	-	0.05	0.2	V	$I_0 = 2mA$
Low Level Output Voltage, V _O	V _{OL}	-	0.02	0.1	V	$I_0 = 2mA$
Offset Supply Leakage Current	I _{LK}	-	-	50	μA	$V_{B} = V_{S} = 600V$
Quiescent V _{BS} Supply Current	I _{BSQ}	-	30	55	μA	$V_{IN} = 0V \text{ or } 5V$
Quiescent V _{CC} Supply Current	I _{CCQ}	-	370	500	μA	$V_{IN} = 0V \text{ or } 5V$
Logic "1" Input Bias Current	I _{IN+}	-	3	10	μA	$V_{IN} = 5V, SD^* = 0V$
Logic "0" Input Bias Current	I _{IN-}	-	-	5	μA	$V_{IN} = 0V, SD^* = 5V$
V _{CC} Supply Under-Voltage Positive Going Threshold	V _{CCUV+}	8.0	8.9	9.8	V	-
V _{CC} Supply Under-Voltage Negative Going Threshold	Vccuv-	7.4	8.2	9.0	V	-
Output High Short Circuit Pulsed Current	I _{O+}	130	210	-	mA	V _O = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	I _{O-}	270	360	-	mA	V _O = 15V, PW ≤ 10µs

Note: 7. The V_{IN} and I_{IN} parameters are applicable to the two logic input pins: IN and SD*. The V_O and I_O parameters are applicable to the respective output pins: HO and LO.

AC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

			, i li l			
Parameter	Symbol	Min	Тур	Max	Unit	Condition
Turn-On Propagation Delay	ton		680	820	ns	$V_{\rm S} = 0V$
Turn-Off Propagation Delay	toff	-	150	220	ns	V _S = 600V
Shutdown Propagation Delay	tsp	_	160	220	ns	-
Delay Matching, HO & LO Turn-On / Turn-Off	t _{DM}			60	ns	-
Turn-On Rise Time	t _R	- <	100	170	ns	$V_{\rm S} = 0V$
Turn-Off Fall Time	t _F	_	50	60	ns	$V_{\rm S} = 0V$
Deadtime: t _{DT LO-HO} & t _{DT HO-LO}	tot	400	520	650	ns	-



Timing Waveforms

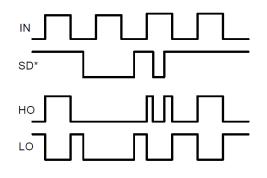


Figure 1. Input / Output Timing Diagram

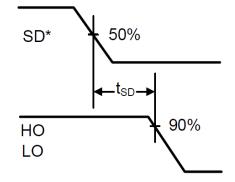
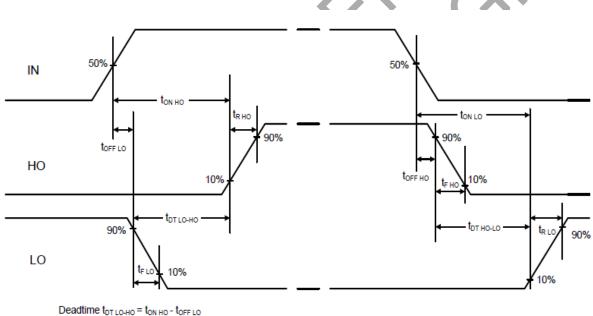


Figure 2. Shutdown Waveform Definition



Deadtime t_{DT LO-HO} = t_{ON HO} - t_{OFF LO} t_{DT HO-LO} = ton LO - toFF HO

> Deadtime matching t_{MDT} = t_{DT LO-HO} - t_{DT HO-LO}

 $\begin{array}{l} \text{Delay matching} \\ t_{\text{DM OFF}} = t_{\text{OFF LO}} - t_{\text{OFF HO}} \\ t_{\text{DM ON}} = t_{\text{ON LO}} - t_{\text{ON HO}} \end{array}$

Figure 3. Switching Time Waveform Definitions



Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.)

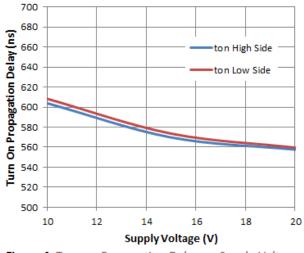


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

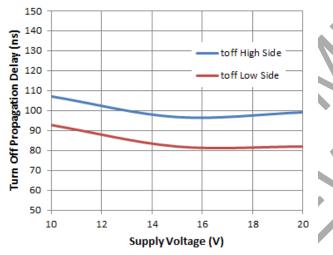


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

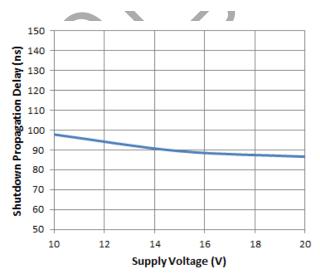


Figure 8. Shutdown Propagation Delay vs. Supply Voltage

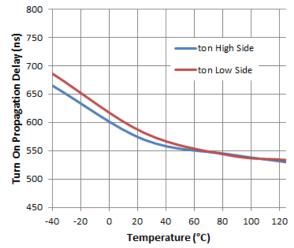


Figure 5. Turn-on Propagation Delay vs. Temperature

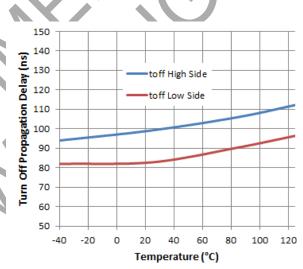


Figure 7. Turn-off Propagation Delay vs. Temperature

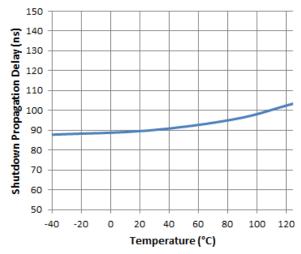
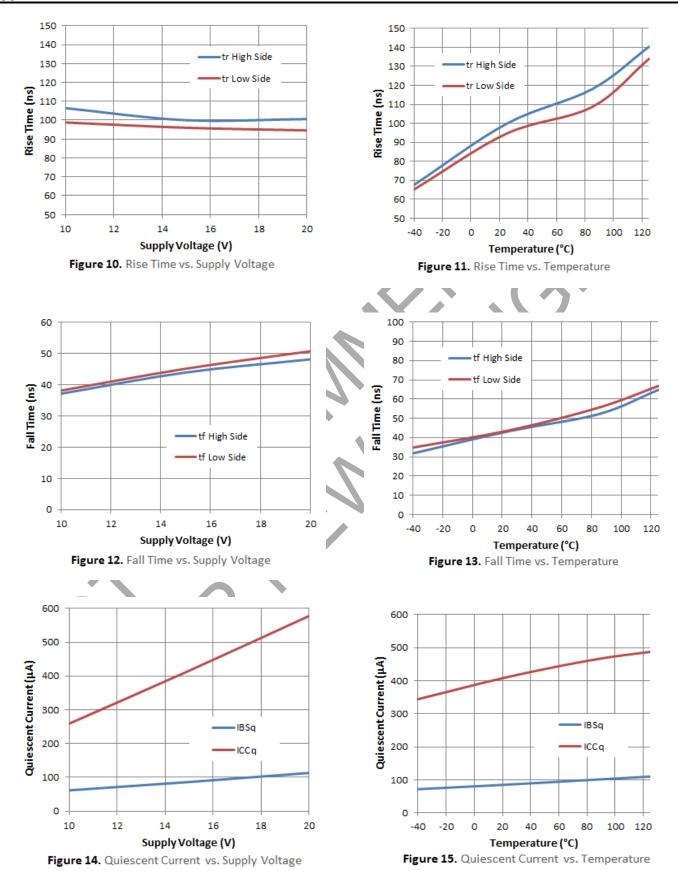
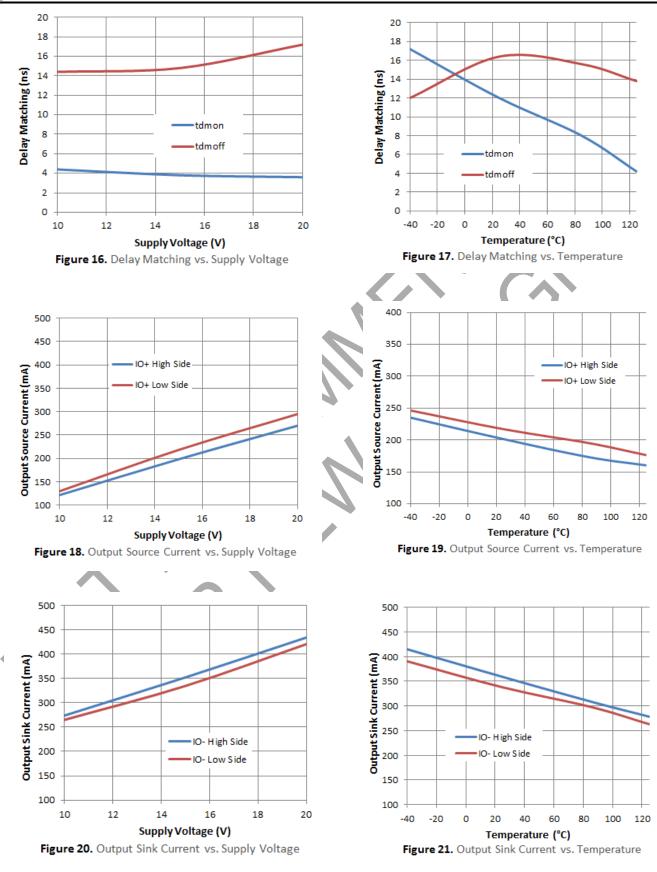


Figure 9. Shutdown Propagation Delay vs. Temperature











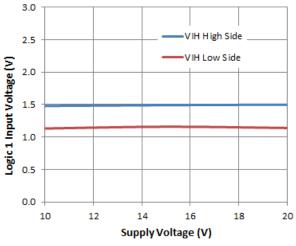


Figure 22. Logic 1 Input Voltage vs. Supply Voltage

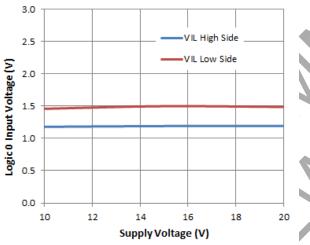
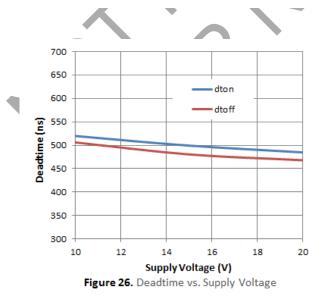


Figure 24. Logic 0 Input Voltage vs. Supply Voltage



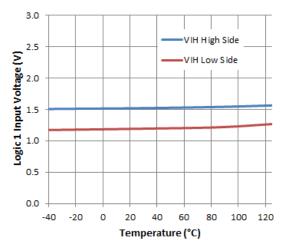
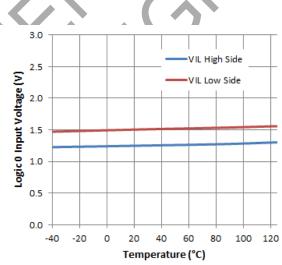
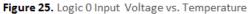
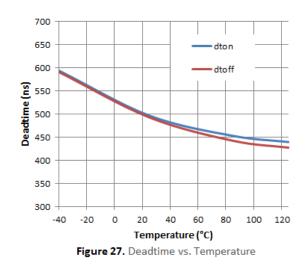


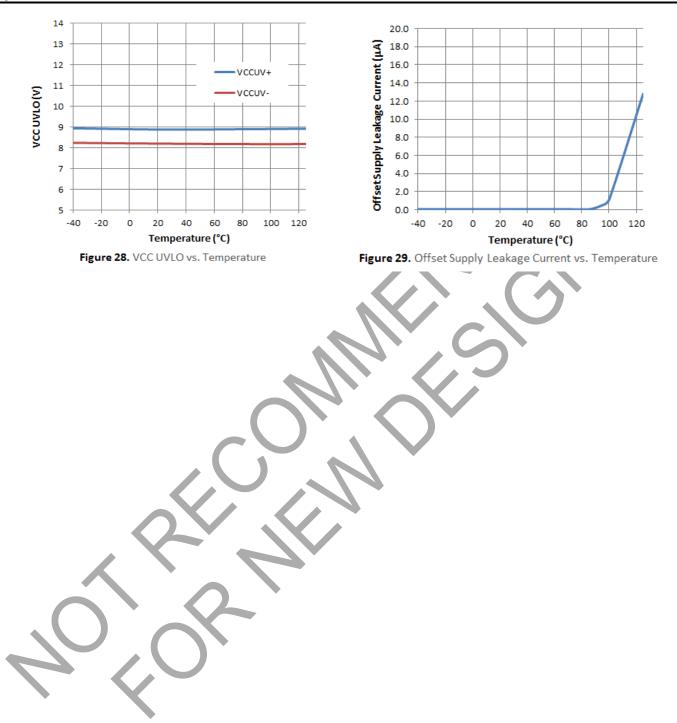
Figure 23. Logic 1 Input Voltage vs. Temperature











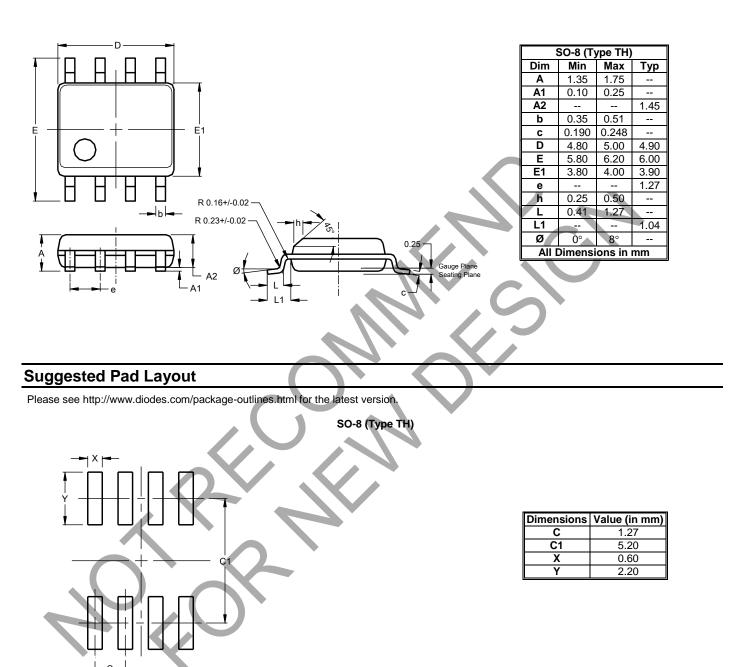


DGD2104A

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Type TH)





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